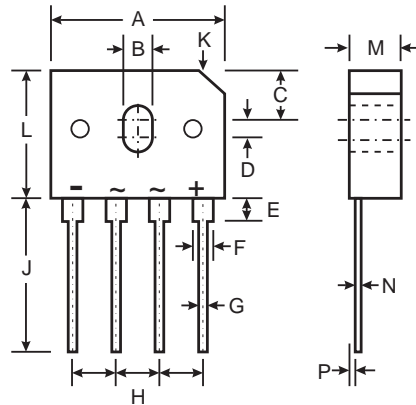


#### Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- High Current Capability
- High Surge Current Capability
- Designed for Surface Mount Application
- Plastic Material – UL Recognition Flammability Classification 94V-0

#### Mechanical Data

- Case: G B U , Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Case
- Weight: 8.0 grams (approx.)
- Mounting Position: Any
- Marking: Type Number
- **Lead Free: For RoHS / Lead Free Version,**



GBU		
Dim	Min	Max
A	21.8	22.3
B	3.5	4.1
C	7.4	7.9
D	1.65	2.16
E	2.25	2.75
F	1.95	2.35
G	1.02	1.27
H	4.83	5.33
J	17.5	18.0
K	3.2 X 45°	
L	18.3	18.8
M	3.30	3.56
N	0.46	0.56
P	0.76	1.0
All Dimensions in mm		

#### Maximum Ratings and Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	GBU	GBU	GBU	GBU	GBU	GBU	GBU	Unit
		10005 15005 25005	1001 1501 2501	1002 1502 2502	1004 1504 2504	1006 1506 2506	1008 1508 2508	1010 1510 2510	
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>								V
Working Peak Reverse Voltage	V <sub>RWM</sub>	50	100	200	400	600	800	1000	
DC Blocking Voltage	V <sub>R</sub>								
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T <sub>A</sub> = 40°C	I <sub>O</sub>	10.0/15.0/25.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	200/200/220							A
Forward Voltage per element @ I <sub>F</sub> = 1.0A	V <sub>FM</sub>	1.1							V
Peak Reverse Current @ T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @ T <sub>A</sub> = 125°C	I <sub>RM</sub>	10.0 500							μA
Typical Junction Capacitance per element (Note 1)	C <sub>j</sub>	70							pF
Typical Thermal Resistance per leg (Note 2)	R <sub>θJA</sub> R <sub>θJL</sub>	20/17/21 4.0							°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150							°C

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.  
2. Mounted on PC board with 13mm<sup>2</sup> copper pad.

FIG.1-MAXIMUM FORWARD SURGE CURRENT

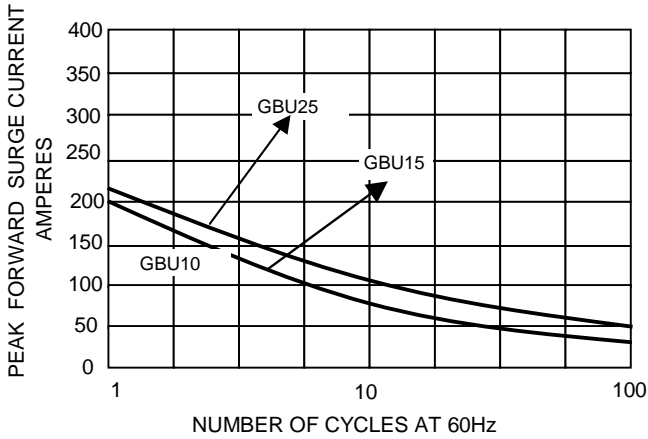


FIG.2- DERATING CURVE  
OUTPUT RECTIFIED CURRENT

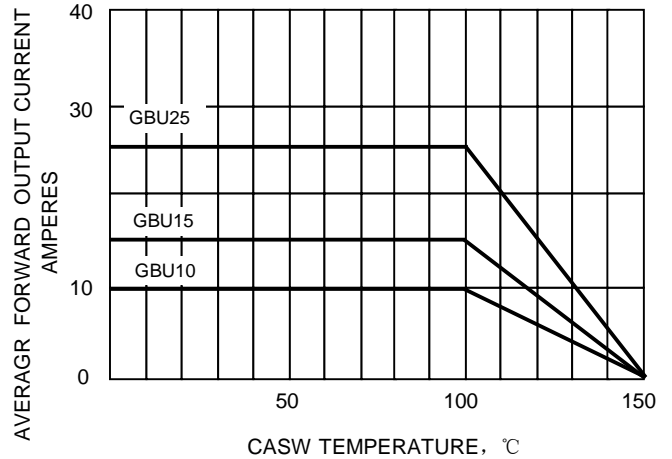


FIG.3-TYPICAL FORWARD CHARACTERISTICS

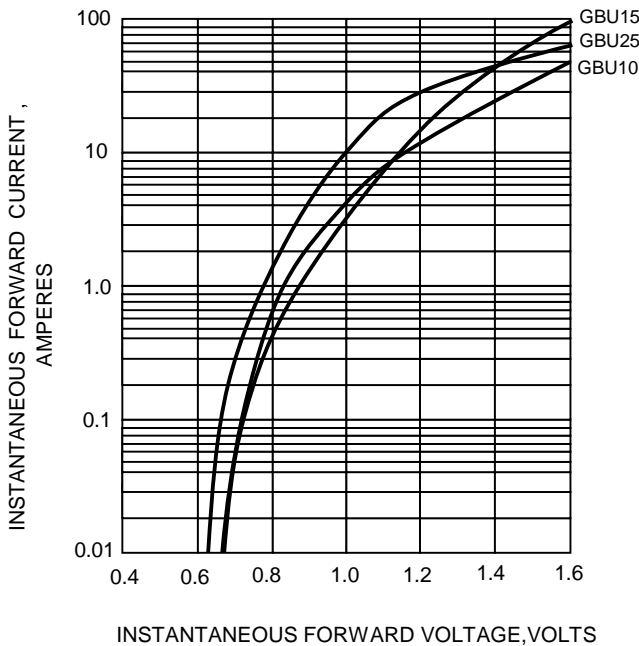


FIG.4-TYPICAL REVERSE CHARACTERISTICS

